



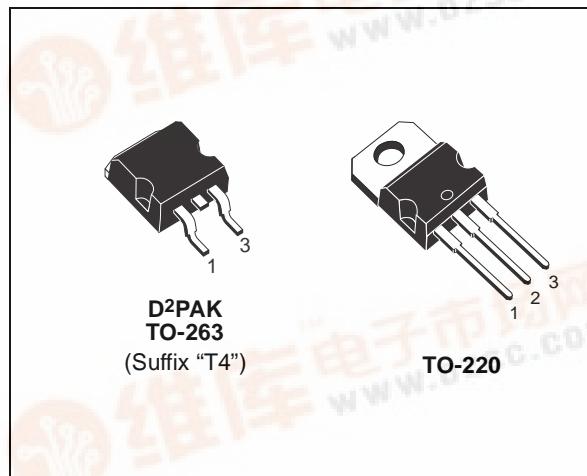
STB135N10 STP135N10

N-CHANNEL 100V - 0.007 Ω - 135A D²PAK/TO-220
LOW GATE CHARGE STripFET™ POWER MOSFET

TARGET DATA

| TYPE | V _{DSS} | R _{D(on)} | I _D |
|-----------|------------------|--------------------|----------------------|
| STB135N10 | 100 V | <0.009 Ω | 135 A ^(*) |
| STP135N10 | 100 V | <0.009 Ω | 135 A ^(*) |

- TYPICAL R_{D(on)} = 0.007 Ω
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- SURFACE-MOUNTING D²PAK (TO-263)
POWER PACKAGE IN TUBE (NO SUFFIX) OR
IN TAPE & REEL (SUFFIX "T4")



DESCRIPTION

This MOSFET is the result of STMicroelectronics's well established and consolidated STripFET technology utilizing the most recent layout optimization. The device exhibits extremely low on-resistance, gate charge and diode's reverse recovery charge Qrr making it the ideal switch in a very large spectrum of applications such as Automotive, Consumer, Telecom and Industrial.

APPLICATIONS

- PRIMARY SWITCH IN TELECOM DC-DC CONVERTER
- HIGH-EFFICIENCY DC-DC CONVERTERS
- 42V AUTOMOTIVE APPLICATIONS
- SYNCHRONOUS RECTIFICATION
- DIESEL INJECTION
- PWM UPS AND MOTOR CONTROL

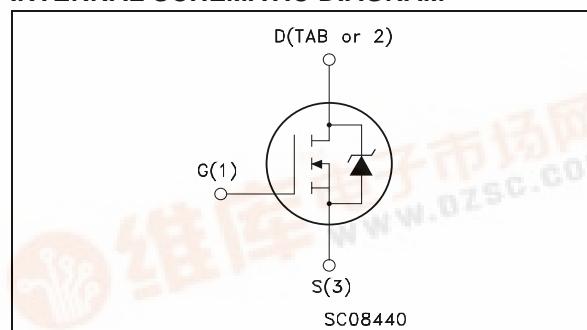
ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|--------------------------------|---|------------|-----------------|
| V _{DS} | Drain-source Voltage (V _{GS} = 0) | 100 | V |
| V _{DGR} | Drain-gate Voltage (R _{GS} = 20 k Ω) | 100 | V |
| V _{GS} | Gate-source Voltage | ± 20 | V |
| I _D ^(*) | Drain Current (continuous) at T _C = 25°C | 135 | A |
| I _D | Drain Current (continuous) at T _C = 100°C | 96 | A |
| I _{DM} ⁽¹⁾ | Drain Current (pulsed) | 540 | A |
| P _{tot} | Total Dissipation at T _C = 25°C | 150 | W |
| | Derating Factor | 1 | W/ $^{\circ}$ C |
| dv/dt ⁽²⁾ | Peak Diode Recovery voltage slope | TBD | V/ns |
| E _{AS} ⁽³⁾ | Single Pulse Avalanche Energy | TBD | mJ |
| T _{stg} | Storage Temperature | -55 to 175 | $^{\circ}$ C |
| T _j | Operating Junction Temperature | | |

(1) Pulse width limited by safe operating area.

(*) Value limited by wire bonding

INTERNAL SCHEMATIC DIAGRAM



(2) I_{SD} ≤ 40A, di/dt ≤ 600A/ μ s, V_{DD} ≤ B_{VDSS}, T_j ≤ T_{JMAX}.

(3) Starting T_j = 25 °C, I_D = 40A, V_{DD} = 50V

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THERMAL DATA

| | | | | |
|---|---|------------|------------------|--------------------|
| Rthj-case Rthj-amb T _I | Thermal Resistance Junction-case Thermal Resistance Junction-ambient Maximum Lead Temperature For Soldering Purpose | Max Max | 1 62.5 300 | °C/W °C/W °C |
|---|---|------------|------------------|--------------------|

ELECTRICAL CHARACTERISTICS (T_{CASE} = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|------------------|---|---|------|------|---------|----------|
| V(BR)DSS | Drain-source Breakdown Voltage | I _D = 250 μA, V _{GS} = 0 | 100 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating V _{DS} = Max Rating T _C = 125°C | | | 1 10 | μA μA |
| I _{GSS} | Gate-body Leakage Current (V _{DS} = 0) | V _{GS} = ± 20V | | | ±100 | nA |

ON (5)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|---|------|-------|-------|------|
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} I _D = 250 μA | 2 | | 4 | V |
| R _{DS(on)} | Static Drain-source On Resistance | V _{GS} = 10 V I _D = 67.5 A | | 0.007 | 0.009 | Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--|---|---|------|--------------------|------|----------------|
| g _{fs} (5) | Forward Transconductance | V _{DS} = 25 V I _D = 67.5 A | | TBD | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25V f = 1 MHz V _{GS} = 0 | | 6350 890 250 | | pF pF pF |

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ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------|--|--|------|-------------------|------|----------------|
| $t_{d(on)}$ t_r | Turn-on Delay Time Rise Time | $V_{DD} = 50 \text{ V}$ $I_D = 67.5 \text{ A}$ $R_G = 4.7 \Omega$ $V_{GS} = 10 \text{ V}$ (Resistive Load, Figure 3) | | TBD TBD | | ns ns |
| Q_g Q_{gs} Q_{gd} | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $V_{DD} = 50 \text{ V}$ $I_D = 135 \text{ A}$ $V_{GS} = 5 \text{ V}$ | | TBD TBD TBD | 95 | nC nC nC |

SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------------------|----------------------------------|--|------|------------|------|----------|
| $t_{d(off)}$ t_f | Turn-off Delay Time Fall Time | $V_{DD} = 50 \text{ V}$ $I_D = 67.5 \text{ A}$ $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ (Resistive Load, Figure 3) | | TBD TBD | | ns ns |

SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|--|---|------|-------------------|------------|--------------------------|
| I_{SD} I_{SDM} (1) | Source-drain Current Source-drain Current (pulsed) | | | | 135 540 | A A |
| V_{SD} (5) | Forward On Voltage | $I_{SD} = 135 \text{ A}$ $V_{GS} = 0$ | | | 1.3 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | $I_{SD} = 135 \text{ A}$ $di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 25 \text{ V}$ $T_j = 150^\circ\text{C}$ (see test circuit, Figure 5) | | TBD TBD TBD | | ns μC A |

(1) Pulse width limited by safe operating area.

(5) Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %.

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Fig. 1: Unclamped Inductive Load Test Circuit

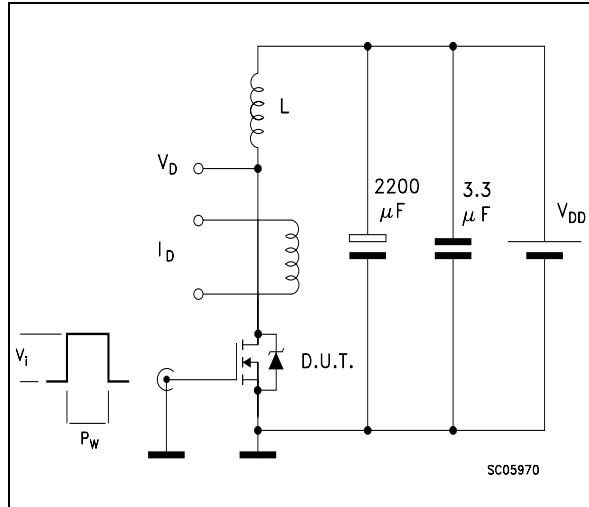


Fig. 2: Unclamped Inductive Waveform

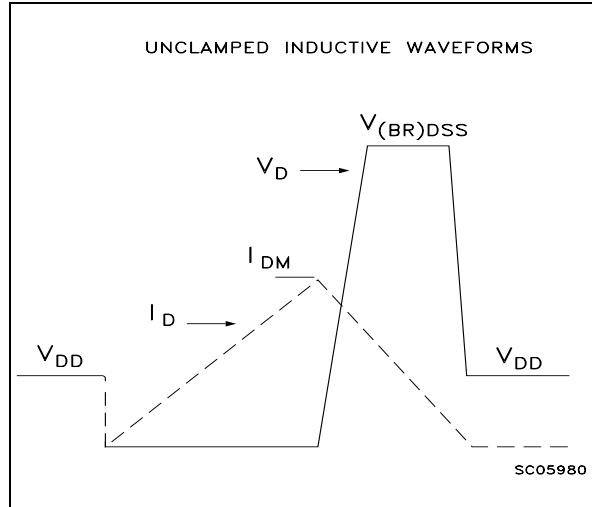


Fig. 3: Switching Times Test Circuits For Resistive Load

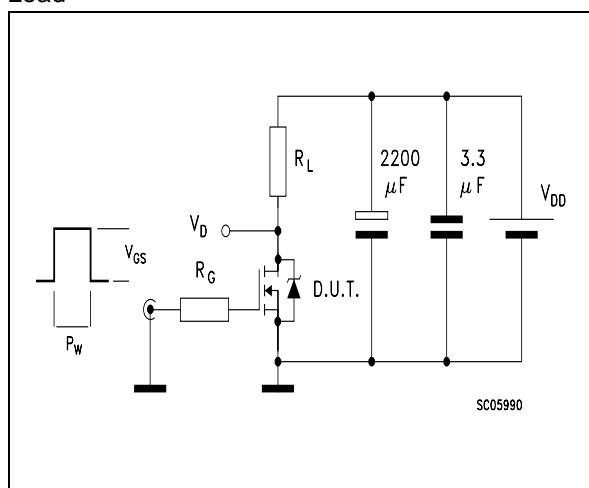


Fig. 4: Gate Charge test Circuit

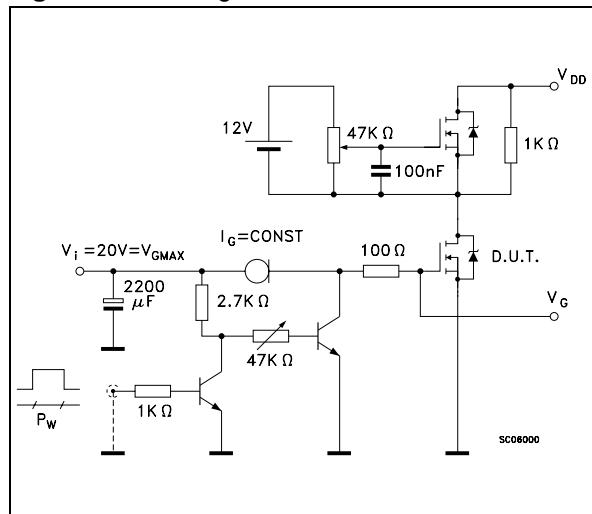
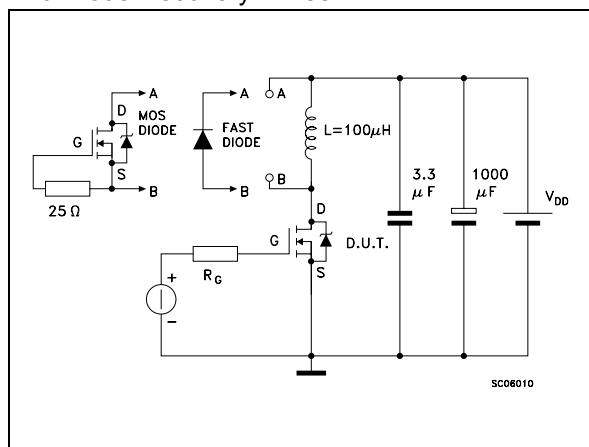


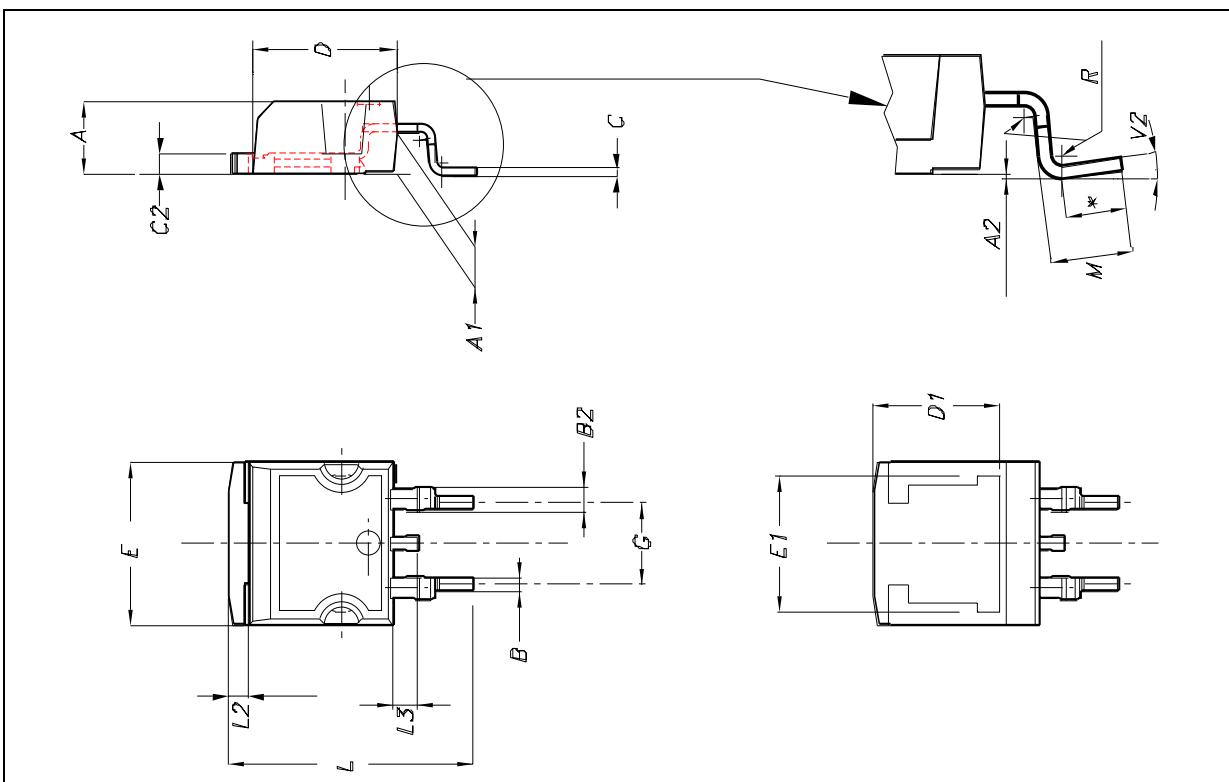
Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times



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D²PAK MECHANICAL DATA

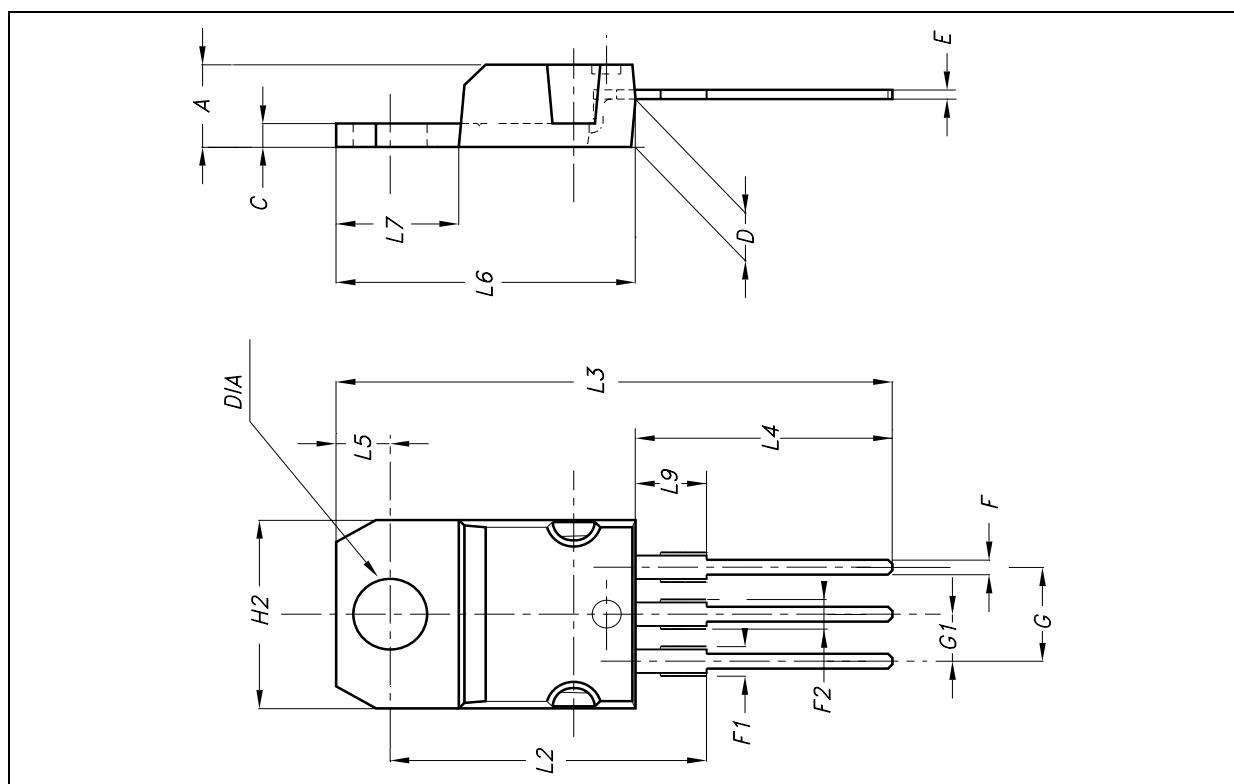
| DIM. | mm. | | | inch. | | |
|------|------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | TYP. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| A1 | 2.49 | | 2.69 | 0.098 | | 0.106 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 |
| B | 0.7 | | 0.93 | 0.028 | | 0.037 |
| B2 | 1.14 | | 1.7 | 0.045 | | 0.067 |
| C | 0.45 | | 0.6 | 0.018 | | 0.024 |
| C2 | 1.21 | | 1.36 | 0.048 | | 0.054 |
| D | 8.95 | | 9.35 | 0.352 | | 0.368 |
| D1 | | 8 | | | 0.315 | |
| E | 10 | | 10.4 | 0.394 | | 0.409 |
| E1 | | 8.5 | | | 0.334 | |
| G | 4.88 | | 5.28 | 0.192 | | 0.208 |
| L | 15 | | 15.85 | 0.591 | | 0.624 |
| L2 | 1.27 | | 1.4 | 0.050 | | 0.055 |
| L3 | 1.4 | | 1.75 | 0.055 | | 0.069 |
| M | 2.4 | | 3.2 | 0.094 | | 0.126 |
| R | | 0.4 | | | 0.015 | |
| V2 | 0° | | 8° | 0° | | 8° |



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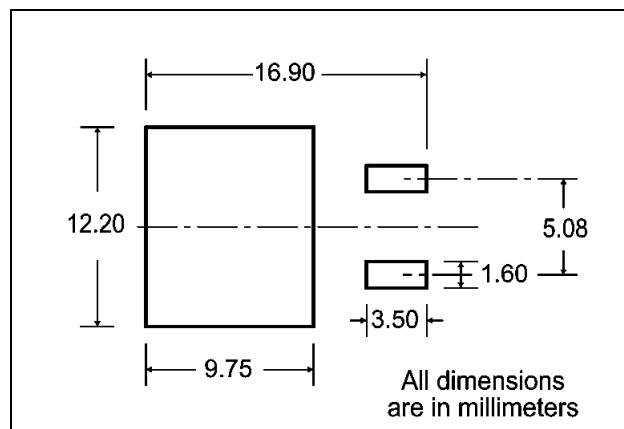
TO-220 MECHANICAL DATA

| DIM. | mm. | | | inch. | | |
|------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | TYP. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| C | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| F2 | 1.14 | | 1.70 | 0.044 | | 0.067 |
| G | 4.95 | | 5.15 | 0.194 | | 0.203 |
| G1 | 2.40 | | 2.70 | 0.094 | | 0.106 |
| H2 | 10 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.40 | | | 0.645 | |
| L3 | | 28.90 | | | 1.137 | |
| L4 | 13 | | 14 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.20 | | 6.60 | 0.244 | | 0.260 |
| L9 | 3.50 | | 3.93 | 0.137 | | 0.154 |
| DIA | 3.75 | | 3.85 | 0.147 | | 0.151 |

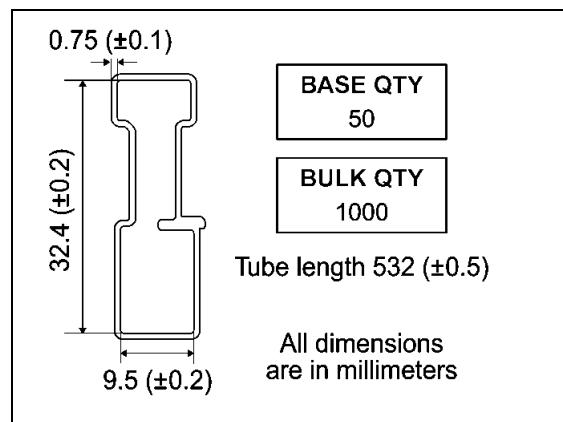


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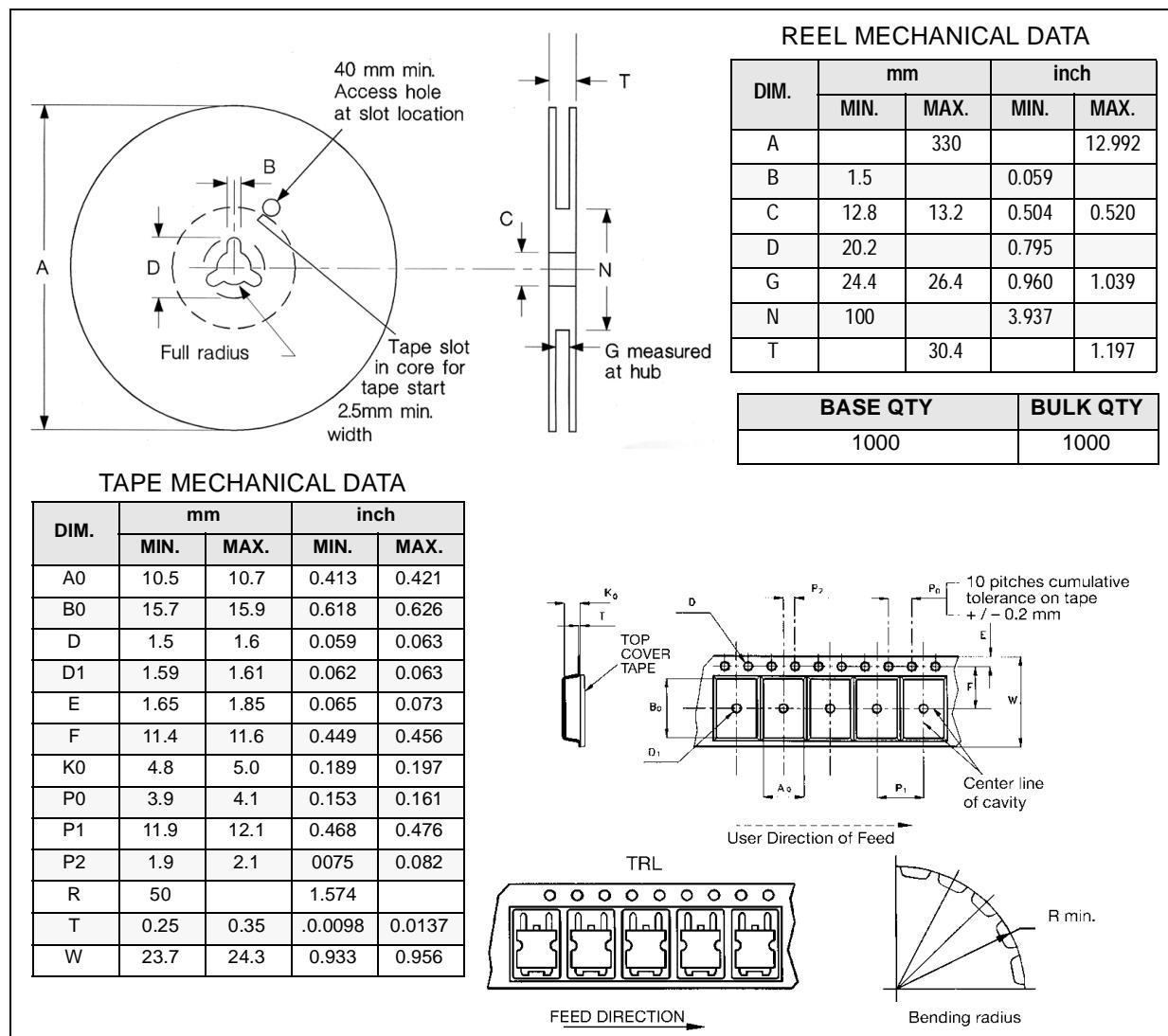
D²PAK FOOTPRINT



TUBE SHIPMENT (no suffix)*



TAPE AND REEL SHIPMENT (suffix "T4")*



* on sales type

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